| <b>PC</b><br>SECUTION CONVECTING<br>COPYRIGH 2005. IPC, Bannockburn, Illinois. All rights reserved under both<br>international and Pan-American copyright conventions. |  |                           |                          |                  | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. |                     |            |                                 |                     |            |                                 |                  |           |  |
|--|--|---------------------------|--------------------------|------------------|---|---------------------|------------|---------------------------------|---------------------|------------|---------------------------------|------------------|-----------|--|
|  | IPC Web Site for Information on IPC-1752 Standard Form Ty  |                           |                          |                  | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materials   |                     |            |                                 |                     | ials and N | ls and Mfg Information          |                  |           |  |
| Supplier Information   |  |                           |                          |                  |   |                     |            |                                 |                     |            |                                 |                  |           |  |
| Company name*  |  |                           | Company unique ID        |                  |   | Unique ID Authority |            |                                 |                     | Respon     | Response Date*                  |                  |           |  |
| onsemi   |  |                           |                          |                  |   |                     |            |                                 |                     | 2024-05-02 |                                 |                  |           |  |
| Contact Name Title - Contact   |  |                           |                          | Phone - Contact* |   |                     |            | Email - Contact*                |                     |            |                                 |                  |           |  |
| Product-Env-Stewards Product Enviro  |  |                           | viro Compliance          |                  | NA  |                     |            | Product-Env-Stewards@onsemi.com |                     |            |                                 |                  |           |  |
| Authorized Representative* Title - Represent   |  |                           | entative                 |                  | Phone - Representative*   |                     |            | Email - Representative*         |                     |            |                                 |                  |           |  |
| Product-Env-Stewards Product   |  |                           | roduct Enviro Compliance |                  |   | NA                  |            |                                 |                     | Produ      | Product-Env-Stewards@onsemi.com |                  |           |  |
| Requester Item Number  | Mfr Item Number  |                           | Mfr Item Name            |                  |   | Effective Date      | Version    | ]                               | Manufacturing Site  |            | Weight*                         | UOM              | Unit Type |  |
|  | A5191H   | A5191HRTNG-XTP A5191HRTNG |                          | ART MODEM        | ASS   | 2024-05-02          |            | ]                               | PHG                 |            | 14.8                            | mg               | Each      |  |
| Manufacturing Proccess Information   | on   |                           |                          |                  |   |                     |            |                                 |                     |            |                                 |                  |           |  |
| Terminal Plating / Grid Array Mat  | Terminal Plating / Grid Array Material Terminal Base Alloy |                           | Alloy J                  | -STD-020 MSL     | Rating  | Peak Proc           | ess Body T | emperatu                        | re Max Time at Peak | Tempera    | ture Numb                       | per of Reflow Cy | cles      |  |
| Matte Tin (Sn) - annealed CU Alloy   |  | 3                         | 3                        |                  | 260   |                     | С          | 30                              | seco                | nds 3      |                                 |                  |           |  |
| Comments   |  |                           |                          |                  |   |                     |            |                                 |                     |            |                                 |                  |           |  |
| ATTENTION: MSL 3 Rated item requires   | Bake and D   | ry Pack (after            | electrical test)         |                  |   |                     |            |                                 |                     |            |                                 |                  |           |  |
| for more information regarding material c  | omposition   | please refer to           | page 3                   |                  |   |                     |            |                                 |                     |            |                                 |                  |           |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Substance Instructions: [A] select<br>select a RoHS exemption, if applie<br>sigma range of distribution unless | cable [E] enter the weigh | , Requester or Supplier) [B<br>tt of the substance or the Pl | ] select the substa<br>PM concentration | ance category (JIG or Requester) or enter<br>[F] Optionally enter the positive (+) ar | er a value (Supplier). [C] selec<br>ad negative (-) tolerance in per | et the substance (JI<br>cent (Note: percer | G) or enter the substa<br>t tolerance values are | nce and CAS (Other). [D]<br>expected to cover a 3 |
|--|---------------------------|--|---|---|--|--|--|---|
| Homogeneous Material   | Weight                    | Unit of Measure  | Level                                   | Substance   | CAS  | Exempt                                     | Weight   | Unit of Measure                                   |
| Die  | 0.25                      | mg   | Supplier                                | Silicon (Si)  | 7440-21-3  |  | 0.25   | mg  |
| Die Attach   | 0.37                      | mg   | Supplier                                | Silver (Ag)   | 7440-22-4  |  | 0.2775   | mg  |
|  |                           |  | Supplier                                | Epoxy resins  | 129915-35-1  |  | 0.0925   | mg  |
| Lead Frame   | 5.81                      | mg   | Supplier                                | Silver (Ag)   | 7440-22-4  |  | 0.9877   | mg  |
|  |                           |  | Supplier                                | Iron (Fe)   | 7439-89-6  |  | 0.0465   | mg  |
|  |                           |  | Supplier                                | Copper (Cu)   | 7440-50-8  |  | 4.7758   | mg  |
| Mold Compound-Black  | 7.0                       | mg   |   | Epoxy Phenol Resin  | proprietary data   |  | 0.735  | mg  |
|  |                           |  | Supplier                                | Fused Silica (SiO2)   | 60676-86-0   |  | 6.265  | mg  |
| Plating  | 0.41                      | mg   | Supplier                                | Tin (Sn)  | 7440-31-5  |  | 0.41   | mg  |
| Wire Bond - Au   | 0.96                      | mg   | Supplier                                | Gold (Au)   | 7440-57-5  |  | 0.96   | mg  |